# SHR3425 Low-Drift, Low-Power, Small-Footprint Series Voltage Reference

#### 1 Features

Initial accuracy: ±0.08% (maximum)

Temperature coefficient: 3 ppm/°C

Operating temperature range: −40°C to +125°C

Output current: ±10 mA

Low quiescent current: 125 μA

Ultra-low zero load dropout voltage: 200 mV

Input voltage: 2.7 ~ 5.5 V

Output 1/f noise (0.1 Hz to 10 Hz): 15 μVp-p/V

Long-term stability: 45 ppm/1000 hrs

Small footprint 6 pin SOT-23 package pinouts:

# 2 Applications

- Data acquisition systems
- Analog I/O modules
- Field transmitters
- Lab & field instrumentation
- Servo drive control modules
- DC power supply, AC source, electronic load

#### 3 Description

The SHR3425 device is a low temperature drift (3 ppm/°C), low-power, high-precision CMOS voltage reference, featuring  $\pm 0.08\%$  initial accuracy, low operating current with power consumption less than 125  $\mu A$ . This device also offers very low output noise of 15  $\mu Vp$ -p/V, which enables its ability to maintain high signal integrity with high-resolution data converters in noise critical systems. With a small SOT-23 package, SHR3425 offers enhanced specifications and pin-to-pin replacement for MAX607x, REF34xx, ADR34xx and LT1790. The SHR3425 is compatible to most of the ADC and DAC.

Stability and system reliability are further improved by the low output-voltage hysteresis of the device and low long-term output voltage drift. Furthermore, the small size and low operating current of the devices (125 µA) benefit portable and battery-powered applications.

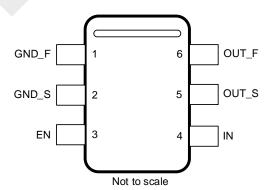
SHR3425 is specified for the wide temperature range of  $-40^{\circ}$ C to  $+125^{\circ}$ C.

#### **Device Information**

PART NAME	PACKAGE (PIN)(1)	BODY SIZE (NOM)
SHR3425	SOT-23 (6)	2.92 mm × 1.62 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet

# **PIN Configuration**





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# 4 Revision History

Date	Revision	Notes
01-2024	V1.1	Production Datasheet



# 5 Pin Configuration and Functions

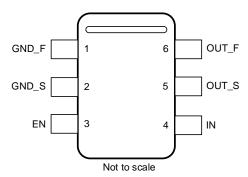


Figure 1. SHR3425 6-Pin SOT-23 Top View

**Table 1. Pin Functions** 

PIN		TYPE	DESCRIPTION		
NAME	PIN	TIPE	DESCRIPTION		
GND_F	1	Ground	Ground force connection.		
GND_S	2	Ground	Ground sense connection.		
EN	3	Input	Enable connection. Enables or disables the device.		
IN	4	Power	Input supply voltage connection.		
OUT_S	5	Input	Reference voltage output sense connection.		
OUT_F	6	Output	Reference voltage output force connection.		

# 6 Specifications

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

·		MIN	MAX	UNIT
lancit caltana	IN	-0.3	5.5	V
Input voltage	EN	-0.3	IN	V
Output voltage	V <sub>OUT</sub>	-0.3	5.5	V
Output short circuit current	I <sub>sc</sub>		30	mA
Operating temperature range	T <sub>A</sub>	-55	150	°C
Storage temperature range	Tstg	-60	150	°C

<sup>(1)</sup> Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied. These are stress ratings only and functional operation of the device at these or any other conditions beyond those specified in the Electrical Characteristics Table is not implied.

# 6.2 ESD Ratings

			VALUE	UNIT
	Electrostotic discharge	Human-body model (HBM), per ANSI/ESDA/ JEDEC JS-001 <sup>(1)</sup>	±2000	V
V <sub>(ESD)</sub>	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±1000	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



# 6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

	<u> </u>	MIN	NOM	MAX	UNI T
IN	Input voltage	V <sub>OUT</sub> + V <sub>DO</sub> <sup>(1)</sup>		5.5	٧
EN	Enable voltage	0		IN	V
IL	Output current	-10		10	mA
T <sub>A</sub>	Operating Temperature	-40	25	125	$^{\circ}$

<sup>(1)</sup> V<sub>DO</sub> = Dropout voltage

### 6.4 Thermal Information

	THERMAL METRIC	SOT23-6	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	131	°C/W
R <sub>θJC</sub> (top)	Junction-to-case (top) thermal resistance	83	°C/W

### 6.5 Electrical Characteristics

At  $V_{IN} = V_{OUT} + V_{DO}$ ,  $C_L = 1~\mu F$ ,  $C_{IN} = 0.1~\mu F$ ,  $I_L = 0~mA$ , minimum and maximum specifications at  $T_A = -40^{\circ}C$  to 125°C;

Typical specifications at  $T_A = 25^{\circ}C$  (Unless otherwise noted).

	PARAMETER	TE	EST CONDITIONS	MIN	TYP	MAX	UNIT	
ACCURAC	Y AND DRIFT	•			•	1	•	
	Output voltage	T <sub>A</sub> = 25°C			2.500		V	
	Output voltage accuracy	T <sub>A</sub> = 25°C		-0.08		+0.08	%	
	Output voltage temperature coefficient	-40°C ≤ T <sub>A</sub> ≤	125°C		3	8	ppm/°C	
LINE & LO	AD REGULATION							
$\Delta V_{O}/\Delta V_{IN}$	Line Regulation	$V_{IN} = V_{OUT} + V_{DO}$ (2) to 5.5 V 15			ppm/V			
		$I_L = 0 \text{ mA to } 10^{-3}$ = $V_{OUT} + V_{DO}$			5			
$\Delta V_{O}/\Delta I_{L}$	Load Regulation	$I_L = 0 \text{ mA} - 10 \text{ m}$	$L = 0 \text{ mA} - 10 \text{mA},$ $T_A = 25^{\circ}\text{C},$ $V_{\text{IN}} = V_{\text{OUT}} + V_{\text{DO}}$ Sinking		20		- ppm/mA	
I <sub>sc</sub>	Short circuit current	$V_{OUT} = 0 \text{ V at}$	T <sub>A</sub> = 25°C		30		mA	
NOISE								
e <sub>np-p</sub>	Low frequency noise	0.1Hz ≤ f ≤ 10	0Hz	15		µV <sub>P-P</sub> /V		
en	Integrated wide band noise	10Hz ≤ f ≤ 10	)kHz	40			$\mu V_{rms}$	
LONG TER	M STABILITY AND HYSTE	RESIS						
	Long-term stability	SOT23-6 Package	0 to 1000h at 25°C		45		ppm	
	Output voltage thermal	SOT23-6	25°C, -40°C,125°C, 25°C Cycle 1	120			+	
	hysteresis	Package 25°C, -40°C,125°C, 60 25°C Cycle 2			ppm			
TURN-ON	TIME							
t <sub>ON</sub>	Turn-on time	0.1% of output	0.1% of output voltage settling, $C_L = 10 \mu F$		5		ms	
CAPACITIN	/E LOAD	1		1			I .	



C <sub>L</sub>	Stable output capacitor range	-40°C ≤ TA ≤ 125°C	0.1	10	μF	
POWER SU	IPPLY		l			
V <sub>IN</sub>	Input voltage		V <sub>OUT</sub> + V <sub>DO</sub>	5.5	V	
IL	Output current capacity	$V_{IN} = V_{OUT} + V_{DO}$ to 5.5 V	-10	10	mA	
	Outroped company	Active mode		125		
IQ	Quiescent current	Shutdown mode		4	μΑ	
.,	EMARIE : K	Voltage reference in active mode (EN = 1)	0.6 × IN		.,,	
V <sub>EN</sub> ENABLE pin voltage		Voltage reference in shutdown mode (EN = 0)		0.5	<b>&gt;</b>	
V	Dropout voltage	I <sub>L</sub> = 0 mA		160		
V <sub>DO</sub>	Dropout voltage	I <sub>L</sub> = 10 mA		250	mV	
I <sub>EN</sub>	ENABLE pin leakage current	$V_{EN} = V_{IN} = 5.5V$		0.1	μΑ	

<sup>(1)</sup> Temperature drift is specified according to the box method.
(2) V<sub>Do</sub> for line regulation test is 300 mV.
(3) V<sub>Do</sub> for load regulation test is 500 mV.



### 6.6 Typical Characteristics

At  $T_A = 25^{\circ}C$ ,  $V_{IN} = V_{EN} = 5.0V$ ,  $I_L=0mA$ ,  $C_L=1\mu F$ ,  $C_{IN}=0.1\mu F$  (unless otherwise noted).

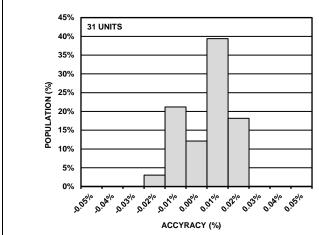


Figure 2: Initial Accuracy

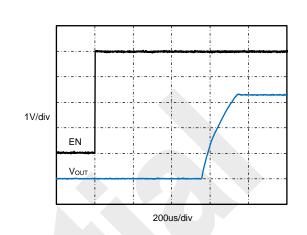


Figure 3: Turnon Time(Enable)

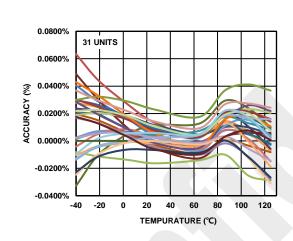


Figure 4: Output Voltage Accuracy vs. Temperature

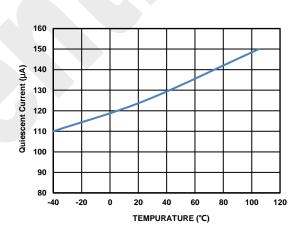


Figure 5: Quiescent Current vs. Temperature

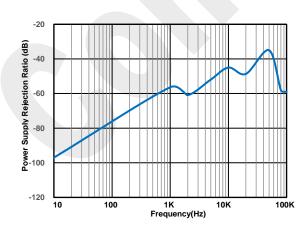


Figure 6: Power-Supply Rejection Ratio vs. Frequency

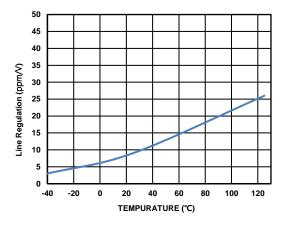
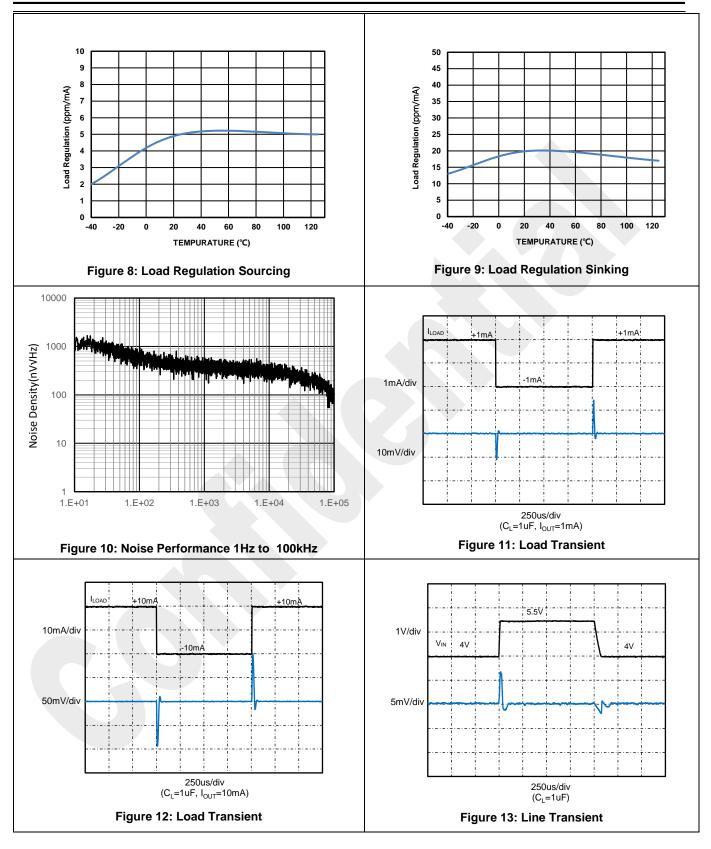
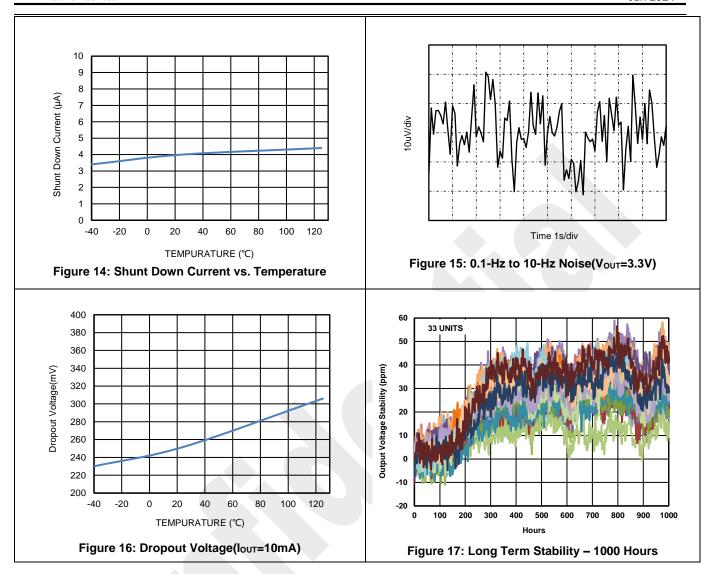


Figure 7: Line Regulation vs. Temperature









### 7 Parameter Measurement Information

### 7.1 Long-Term Stability

One of the key parameters of the SHR3425 references is long-term stability. Typical characteristic expressed as: Figure 17 show the typical drift value for the SHR3425 is 45 ppm from 0 to 1000 hours. This parameter is characterized by measuring 33 units at regular intervals for a period of 1000 hours. It is important to understand that long-term stability is not ensured by design and that the output from the device may shift beyond the typical 30 ppm specification at any time. For systems that require highly stable output voltages over long periods of time, the designer should consider burning in the devices prior to use to minimize the amount of output drift exhibited by the reference over time.

### 7.2 Power Dissipation

The SHR3425 voltage references are capable of source and sink up to 10 mA of load current across the rated input voltage range. However, when used in applications subject to high ambient temperatures, the input voltage and load current must be carefully monitored to ensure that the device does not exceeded its maximum power dissipation rating. The maximum power dissipation of the device can be calculated with Equation 1:

$$T_{J} = T_{A} + P_{D} \times R_{\theta J A} \tag{1}$$

where

P<sub>D</sub> is the device power dissipation



- T<sub>J</sub> is the device junction temperature
- T<sub>A</sub> is the ambient temperature
- R<sub>0JA</sub> is the package (junction-to-air) thermal resistance

Because of this relationship, acceptable load current in high temperature conditions may be less than the maximum currentsourcing capability of the device. In no case should the device be operated outside of its maximum power rating because doing so can result in premature failure or permanent damage to the device.

### 7.3 Noise Performance

Typical 0.1-Hz to 10-Hz voltage noise can be seen in Figure 18. Device noise increases with output voltage and operating temperature. Additional filtering can be used to improve output noise levels, although care must be taken to ensure the output impedance does not degrade ac performance. Peak-to-peak noise measurement setup is shown in Figure 18.

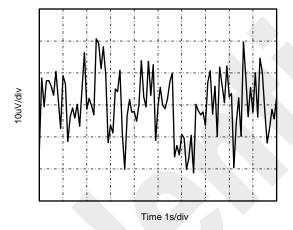
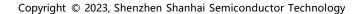


Figure 18: 0.1-Hz to 10-Hz Noise(Vout=3.3V)





### 8 Detailed Description

#### 8.1 Overview

The SHR3425 is family of low-noise, precision bandgap voltage references that are specifically designed for excellent initial voltage accuracy and drift. The Section 8.2 is a simplified block diagram of the SHR3425 showing basic band-gap topology.

#### 8.2 Functional Block Diagram

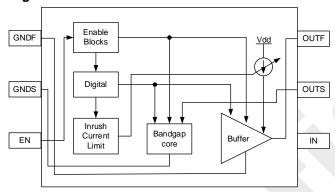


Figure 19: Functional Block Diagram

## 8.3 Feature Description

#### 8.3.1 Supply Voltage

The SHR3425 family of references features an extremely low dropout voltage. For loaded conditions, a typical dropout voltage versus load is shown on the front page. The SHR3425 features a low quiescent current that is extremely stable over changes in both temperature and supply. The typical room temperature quiescent current is 125  $\mu$ A, and the maximum quiescent current over temperature is just 150  $\mu$ A. Supply voltages below the specified levels can cause the SHR3425 to momentarily draw currents greater than the typical quiescent current. Use a power supply with a fast rising edge and low output impedance to easily prevent this issue.

#### 8.3.2 Low Temperature Drift

The SHR3425 is designed for minimal drift error, which is defined as the change in output voltage over temperature. The drift is calculated using the box method, as described by Equation 2. For this equation, V<sub>REF</sub> is V<sub>OUT</sub> which is the output voltage seen at the junction of OUT\_F and OUT\_S.

Drift = 
$$\left(\frac{V_{REF(MAX)} - V_{REF(MIN)}}{V_{REF(25^{\circ})} \times \text{Temperature Range}}\right) \times 10^{6}$$
 (2)

#### 8.3.3 Load Current

The SHR34xx family is specified to deliver a current load of ±10 mA per output. The device temperature increases according to Equation 3:

$$T_{J} = T_{A} + P_{D} \times R_{\theta J A} \tag{3}$$

where

- T<sub>J</sub> = junction temperature (°C)
- T<sub>A</sub> = ambient temperature (°C)
- P<sub>D</sub> = power dissipated (W), and
- R<sub>θJA</sub> = junction-to-ambient thermal resistance (°C/W)

The SHR3425 maximum junction temperature must not exceed the absolute maximum rating of 150°C.

#### 8.4 Device Functional Modes

#### 8.4.1 EN Pin

When the EN pin of the SHR3425 is pulled high, the device is in active mode. The device must be in active mode for normal operation. The SHR3425 can be placed in a low-power mode by pulling the enable pin low. When in shutdown mode, the output of the device becomes high impedance and the quiescent current of the device reduces to  $4 \mu A$  in shutdown mode. The EN pin must not be pulled higher than VIN supply voltage. See the Section 6.5for logic high and logic low voltage levels.

#### 8.4.2 Negative Reference Voltage

For applications requiring a negative and positive reference voltage, the SHR3425 can be used to provide a dual-supply reference from a 5V supply. Figure 20: SHR3425 Create Positive and Negative Reference Voltages shows the SHR3425 used to provide a 3.3V supply reference voltage. Take care to match the temperature coefficients of R1 and R2.

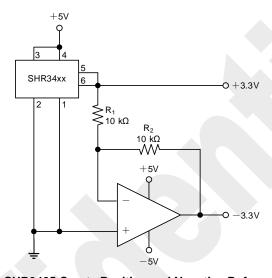


Figure 20: SHR3425 Create Positive and Negative Reference Voltages

# 9 Power Supply Recommendations

The SHR3425 family of references feature an extremely low-dropout voltage. These references can be operated with a supply of only 250 mV above the output voltage. Sensilicon recommends a supply bypass capacitor ranging between 0.1  $\mu$  F to 10  $\mu$  F.

# 10 Layout

#### 10.1 Layout Guidelines

Figure 21 illustrates an example of a PCB layout for a data acquisition system using the SHR3425.Some key considerations are:

- Connect low-ESR,0.1- μ F ceramic bypass capacitors at IN,OUT F,VOUT of the SHR3425.
- Decouple other active devices in the system per the device specifications.
- Using a solid ground plane helps distribute heat and reduce electromagnetic interference(EMI)noise pickup.
- Place the external components as close to the device as possible. This configuration prevents parasitic errors (such as the Seebeck effect) from occurring.
- Do not run sensitive analog traces in parallel with digital traces. Avoid crossing digital and analog traces if possible, and only make perpendicular crossings when absolutely necessary.



# 10.2 Layout Example

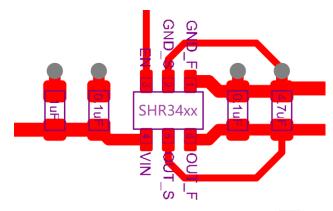
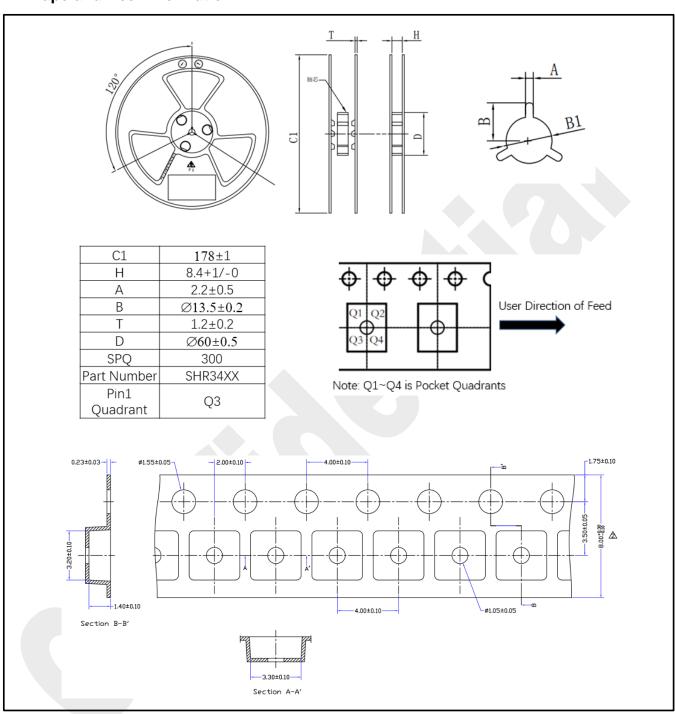


Figure 21: SHR3425 PCB Layout Example

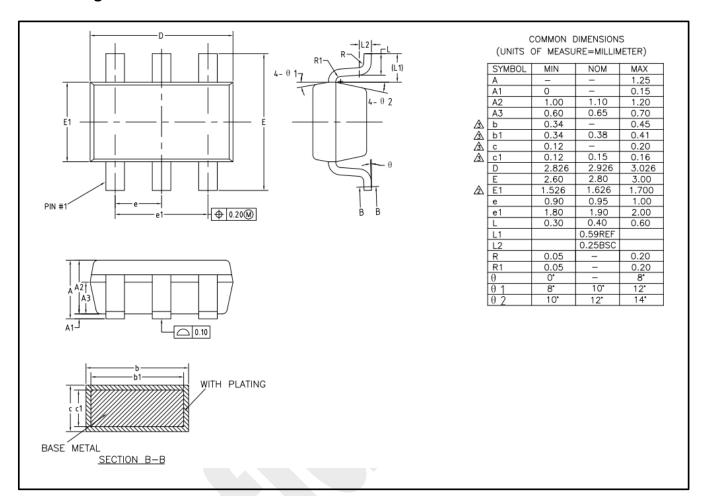


# 11 Tape and Reel Information





# 12 Package Information





# 13 Ordering Guide

Orderable Device	Package	Package Qty	Op Temp (°C)	MSL	RoHS (Pb Free)
SHR3425SST6IR	SOT23-6	3000	-40 to 125°C	Level 1	Yes
SHR3425SST6IT	SOT23-6	250	-40 to 125°C	Level 1	Yes

